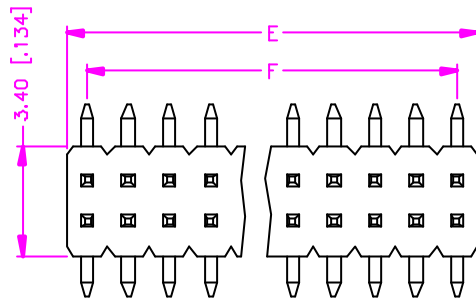
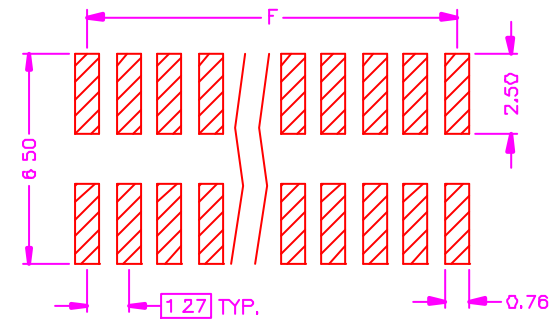
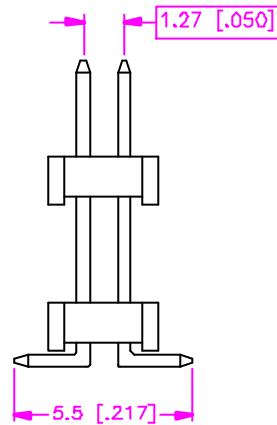
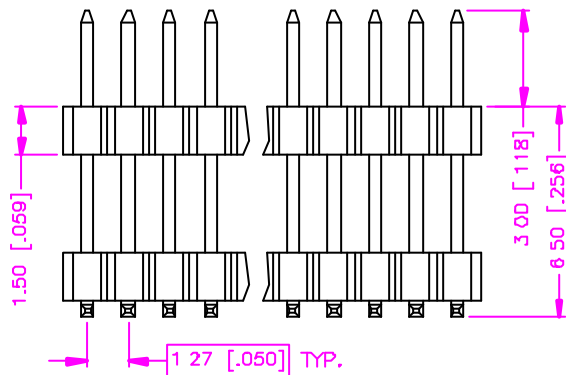


| REV. | DESCRIPTION | DATE |
|------|-------------|---------------|
| — | RELEASE | Mar. 01, 2002 |
| 1 | | |
| 2 | | |



$$E = (\text{NO. OF POSITION PER ROW}) \times 1.27 \pm 0.30$$

$$F = (\text{NO. OF POSITION PER ROW} - 1) \times 1.27$$



RECOMMEND P.C.B. LAYOUT
TOP VIEW

MATERIALS

- HOUSING : HI.-TEMP. PLASTIC (UL 94V-0), BLACK.
- TERMINAL : S.Q. 0.40mm COPPER ALLOY.

SPECIFICATION

- CURRENT RATING : 1 AMP. MAX.
- DIELECTRIC WITHSTANDING VOLTAGE : 600V AC R.M.S. FOR ONE MINUTE
- INSULATION RESISTANCE : 5000M OHMS MIN. AT 500V DC.
- OPERATING TEMPERATURE -55°C TO +105°C.
- MAX. PROCESSING TEMPERATURE : 230°C FOR 30 ~ 60 SECONDS.

ORDER INFORMATION :

27 - 45 02 - 2 ** - * G

SERIES CODE | TYPE 02 | DUAL ROWS | NUMBER OF POSITIONS PER ROW

GOLD PLATING ON SOLDER TAIL

CONTACT PLATING OPTIONS

- GOLD FLASH
- .000010" GOLD
- .000015" GOLD
- .000030" GOLD

| | | | | |
|--|---|--|----------|-----------------------|
| TOLERANCE .0±.0.30 [.012] .00±.0.20 [.008] 000±.XXX ANG.=±3° | DRAWER <i>FUS</i> CHECK <i>Katherine</i> APP'D <i>ASST</i> | ASTRON TECHNOLOGY CORP. NAME POST HEADER 1.27x1.27mm PITCH, P.C.B. MOUNT SMT ELEVATE | | |
| UNITS : mm [inch] | PRODUCT SPEC. — | | | |
| SCALE NONE | SIZE A4 | SHEET 1 DF 1 | REV A | DRAW NO. C333-5002 |
| | | | | 05005 |